



## DFLR1200/DFLR1400/DFLR1600

### 1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

### **Features**

- Ideally Suited for Automated Assembly
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 <a> § 3</a>
- Terminal Connections: Cathode Band
- Weight: 0.01 grams (approximate)

#### PowerDI123



Top View

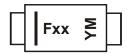
### Ordering Information (Note 4)

Part Number	Marking Code	Case	Packaging
DFLR1200-7	F12	PowerDI123	3,000/Tape & Reel
DFLR1400-7	F14	PowerDI123	3,000/Tape & Reel
DFLR1600-7	F18	PowerDI123	3,000/Tape & Reel

### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



Fxx = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: Y = 2013)

M = Month (ex: 9 = September)

#### Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		Α	I	3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	DFLR1200	DFLR1400	DFLR1600	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	600	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	140	280	420	V
Average Rectified Output Current (see figure 4)	lo		1.0		Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	25			Α

### Thermal Characteristics

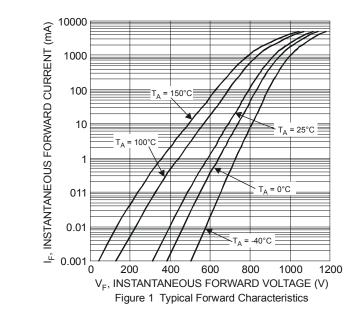
Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Ambient Air (Note 5)	RθJA	134		mW
Thermal Resistance, Junction to Soldering Point (Note 6)	Rejs	_	6	°C/W
Operating and Storage Temperature Range	TJ, TSTG	_	-65 to +150	°C

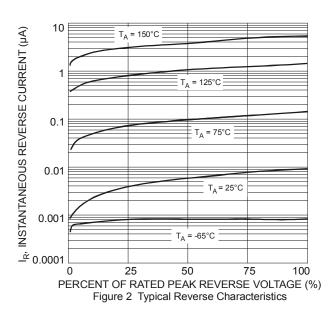
### Electrical Characteristic (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Forward Voltage	@ I <sub>F</sub> = 1.0A	$V_{FM}$	1.1	V
Peak Reverse Leakage Current	@ T <sub>A</sub> = +25°C		3.0	μA
at Rated DC Blocking Voltage	@ T <sub>A</sub> = +125°C	I <sub>RM</sub>	100	μΑ
Typical Total Capacitance (f = 1MHz, V <sub>R</sub> = 4.0VDC)		$C_{T}$	10	pF

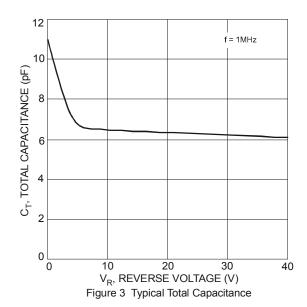
Notes:

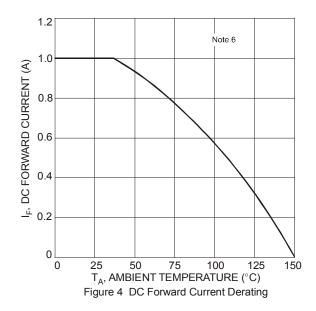
- 5. Theoretical R 8 JS calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- 6. Device mounted on 1" x 1", FR-4 PCB; 2 oz. Cu pad layout as shown on Diodes Inc. suggested pad layout document AP02001.pdf. T<sub>A</sub> = +25°C 7. Short duration pulse test used to minimize self-heating effect.





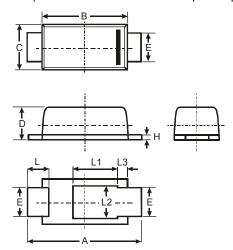






# **Package Outline Dimensions**

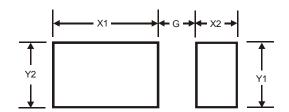
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI®123						
Dim	Min	Max	Тур			
Α	3.50	3.90	3.70			
В	2.60	3.00	2.80			
С	1.63	1.93	1.78			
D	0.93	1.00	0.98			
Ε	0.85	1.25	1.00			
Н	0.15	0.25	0.20			
L	0.40	0.50	0.45			
L1	-	-	1.35			
L2	-	-	1.10			
L3	-	-	0.20			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4





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